



DMN33D8LTQ

Product Summary

BV _{DSS}	R _{DS(ON)}	Ι _D T _A = +25°C
30V	5Ω @ V _{GS} = 4V	200mA
307	7Ω @ V _{GS} = 2.5V	115mA

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Brushless DC Motor Control
- DC-DC Converters
- Load Switch

Features

- N-Channel MOSFET
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate 2KV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
 Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN33D8LTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

N-CHANNEL ENHANCEMENT MODE MOSFET

https://www.diodes.com/quality/product-definitions/

Mechanical Data

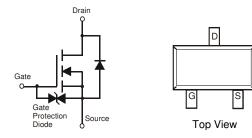
- Case: SOT523
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed Over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208³
- Terminal Connections: See Diagram
- Weight: 0.002 grams (Approximate)





SOT523

Top View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN33D8LTQ-7	SOT523	3,000/Tape & Reel
DMN33D8LTQ-13	SOT523	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Γ	3LT	YM	
-			1

3LT = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Notes:

Year	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	F	G	Н		J	K	L	М	Ν	0	Р	R
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		VDSS	30	V
Gain-Source Voltage		V _{GSS}	±20	V
Drain Current (Note 5)	Continuous	ID	115	mA

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	240	mW
Thermal Resistance, Junction to Ambient (Note 5)	Reja	521	°C/W
Total Power Dissipation (Note 6)	PD	300	mW
Thermal Resistance, Junction to Ambient (Note 6)	Reja	420	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

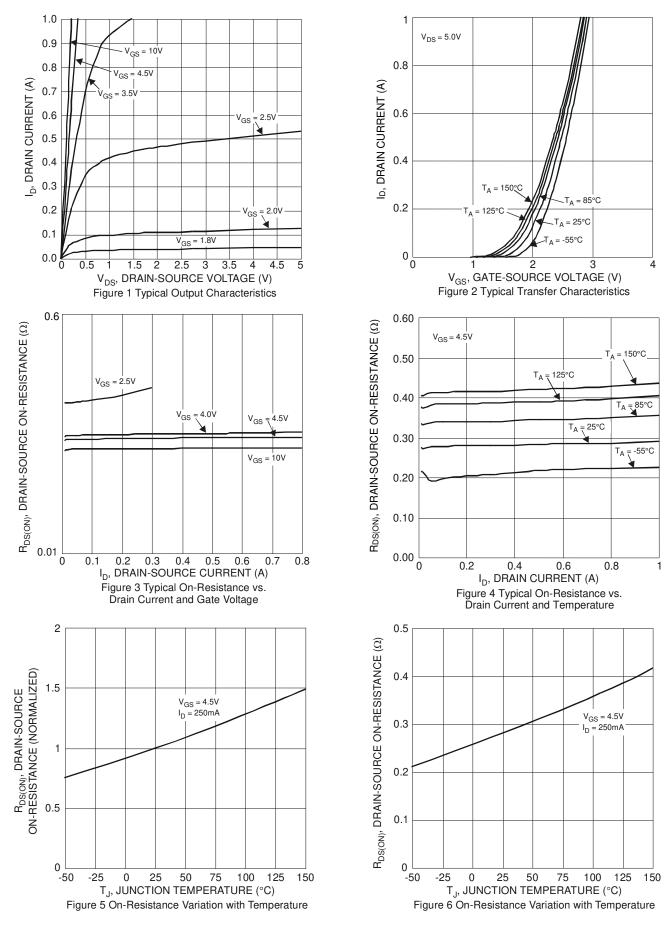
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)	Cymbol		1.76	Ших	onit			
Drain-Source Breakdown Voltage	BV _{DSS}	30			V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current		_		1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$		
Gate-Body Leakage	lgss			±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	VGS(TH)	0.8		1.5	V	V _{DS} = 3V, I _D = 100µA		
Static Drain-Source On-Resistance	Deserve	_		5	Ω	$V_{GS} = 4V$, $I_D = 10mA$		
Static Drain-Source On-Resistance	RDS(ON)	_		7	Ω	$V_{GS} = 2.5V, I_D = 5mA$		
Diode Forward Voltage	VSD	_		1.2	V	V _{GS} = 0V, I _S = 115mA		
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	Ciss	_	48	_				
Output Capacitance	Coss	_	11	_	pF	$V_{DS} = 5V, V_{GS} = 0V, f = 1.0MHz$		
Reverse Transfer Capacitance	Crss	_	8	_				
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	0.55	_				
Total Gate Charge (V _{GS} = 10V)	Qg	_	1.23	—	nC	$V_{GS} = 10V, V_{DS} = 10V,$		
Gate-Source Charge	Qgs	_	0.14	_	nc	I _D = 250mA		
Gate-Drain Charge	Q _{gd}	_	0.14	_				
Turn-On Delay Time	tD(ON)		2.9					
Turn-On Rise Time	tR		2.6		ns	VDD = 30V, ID = 0.2A, VGEN = 10V,		
Turn-Off Delay Time	tD(OFF)		18.2	_	115	$R_{GEN} = 25\Omega$		
Turn-Off Fall Time	tF		13.6					

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:

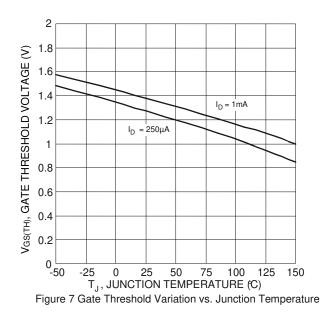


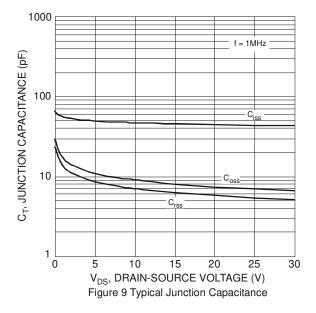
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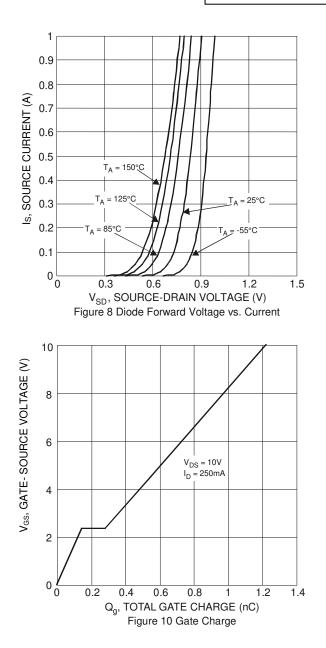


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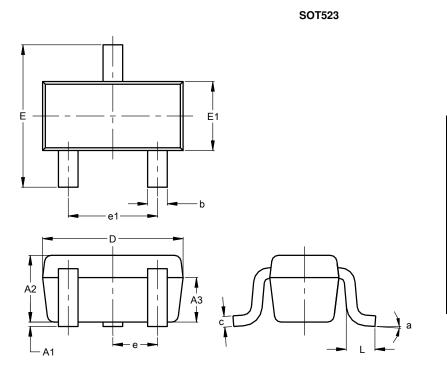






Package Outline Dimensions

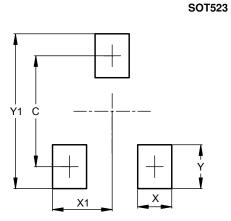
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT523						
Dim	Min Max Typ					
A1	0.00	0.10	0.05			
A2	0.60	0.80	0.75			
A3	0.45	0.65	0.50			
b	0.15	0.30	0.22			
С	0.10	0.20	0.12			
D	1.50	1.70	1.60			
Е	1.45	1.75	1.60			
E1	0.75	0.85	0.80			
е		0.50 BS	С			
e1	0.90	1.10	1.00			
L	0.20	0.40	0.33			
а	0°		8°			
Α	II Dimen	isions ir	n mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.29
Х	0.40
X1	0.70
Y	0.51
Y1	1.80



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